

# 180605311 Change of Substrate Core Material, Si504x

PCN Issue Date: 6/5/2018

Effective Date: 9/11/2018

PCN Type: Assembly

#### **Description of Change**

Silicon Labs is pleased to announce a change of substrate core material from HL832NX to HL832NX(A). HL832NX(A) type is an improved version and a direct substitute of HL832NX type in terms of better peel strength, better lamination windows and lower water absorption rate. This change will also ensure long term continuity of supply.

There is no change to trace design, substrate construction and appearance.

As of the effective date of the PCN, Silicon Labs will continue to fulfill orders using both substrate core material types.

The package qualification report is attached.

## **Reason for Change**

For production continuity and better performance.

## Impact on Form, Fit, Function, Quality, Reliability

There is no change on form, fit, function, quality & reliability of this product

## **Product Identification**

SI5040-D-GM SI5040-D-GMR SI5040-D-ZM2 SI5040-D-ZM3 SI5040-D-ZM3R SI5040-D-ZM3R SI5040-D-ZM6 SI5040-D-ZM7 SI5040-D-ZM7 SI5041-D-ZM1 SI5041-D-ZM1

Last Date of Unchanged Product: 9/11/2018

#### **Qualification Samples**

Available upon request.

#### **Customer Response**

Lack of acknowledgment of the PCN within 30 days constitutes acceptance of the change, Ref. JEDEC-J-STD-046.

To request further data or inquire about this notification, please contact your Silicon Labs sales representative. A list of Silicon Labs sales representatives is available at <a href="http://www.silabs.com">http://www.silabs.com</a>.

Customers may approve early PCN acceptance by emailing approval, along with PCN # to PCNEarlyAcceptance@silabs.com

#### **User Registration**

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#### **Qualification Data**

Please see below qualification reports.



#### Si5040/41 Qualification Report

Part Rev E, TSM	IC Fabrication, SPIL Assem	bly except as no	ted				
Test Name	Test Condition	Qualification	Lot ID or Start	Fail/Pass or End	Notes	Summary	Status
	ccelerated Environment Stress	Tests					
HAST	JA110		Q042554	0/25	1		
	130°C, 85%RH	3 lots, N=>25	Q042555	0/24	1	3 lots	Pass
	Vcc=1.8V, 96 hours		Q042556	0/25	1	0/74	
Temp Cycle	JA104		Q042550	0/25	1		
	Cond C: -65°C to 150°C	3 lots, N=>25	Q042551	0/24	1	3 lots	Pass
	500 cycles		Q042552	0/25	1	0/74	
HTSL	JA103		Q025275	0/80	1, 2		
	150°C, 1000hr	3 lots, N=>25	Q025709	0/80	1, 2	3 lots	Pass
			Q025710	0/80	1, 2	0/240	
Test Group B – A	ccelerated Lifetime Simulation	Tests					
HTOL	JA108		Q025931	0/78	3		
	T <sub>J</sub> ≥ 125°C, Dynamic	3 lots, N=>77	Q025932	0/80	3	3 lots	Pass
	Vcc=1.8V, 1000 hours		Q026734	0/80	3	0/238	
LTOL	JA108						
	T <sub>A</sub> = -10°C, Dynamic	1 lot, N=>32	Q026576	0/80	3	1 lots	Pass
	Vcc=1.8V, 1000 hours					0/80	
ELFR	JA108		Q025707	0/500	3		
	T <sub>1</sub> ≥ 125°C, Dynamic	3 lots, N=>500	Q025708	0/500	3	3 lots	Pass
	Vcc=1.8V, 48 hours		Q026872	0/500	3	0/1500	
Test Group E – El	ectrical Verification						
ESD-HBM	JA114						
		1 lot, N=>3	Q025142		3	2.5 kV	Class 2
ESD-CDM	JESD22-C101						
		1 lot, N=>3	Q025276		3	1000 V	Class IV
Latch Up	JESD78						
	±200mA	1 lot, N=>3	Q025277	70°C	3		Pass
	Overvoltage = 5.1975V						

Notes:

1. Parts are Pre-conditioned at MSL3/260°C 2. Leveraged package family qualification data 3. Leveraged die family qualification data

Si5040-D-GM	Si5040-D-GMR	Si5040-D-ZM2	Si5040-D-ZM2R	CE040 D 740
SI SOMO: Dr.G.M.	212040-D-OMIK	313040-D-ZMZ	313040-D-ZMZK	Si5040-D-ZM3
Si5040-D-ZM3R	Si5040-D-ZM6	Si5040-D-ZM6R	SI5040-D-ZM7	Si5040-D-ZM7R
Si5041-D-ZM1	Si5041-D-ZM1R			

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Prepared on: 23-May-2018 by N. Arguello



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